DATASHEET

General Description

The 9ZX21901 is Intel DB1900Z Differential Buffer suitable for PCI-Express Gen3 or QPI applications. The part is backwards compatible to PCIe Gen1 and Gen2. A fixed external feedback maintains low drift for critical QPI applications. In bypass mode, the 9ZX21901 can provide outputs up to 400MHz.

Recommended Application

• 19-output PCIe Gen3/QPI buffer with fixed feedback for Romley platforms

Output Features

• 19 – 0.7V current mode differential HCSL output pairs

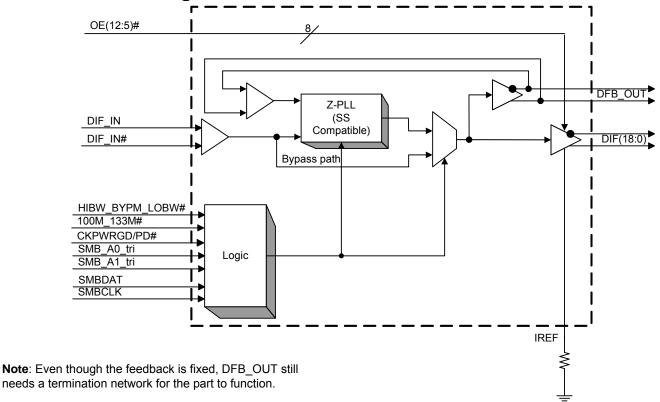
Key Specifications

- Cycle-to-cycle jitter: < 50ps
- Output-to-output skew: <65ps
- Input-to-output delay: Fixed at 0 ps
- Input-to-output delay variation: <50ps
- Phase jitter: PCle Gen3 < 1ps rms
- Phase jitter: QPI 9.6GB/s < 0.2ps rms

Features/Benefits

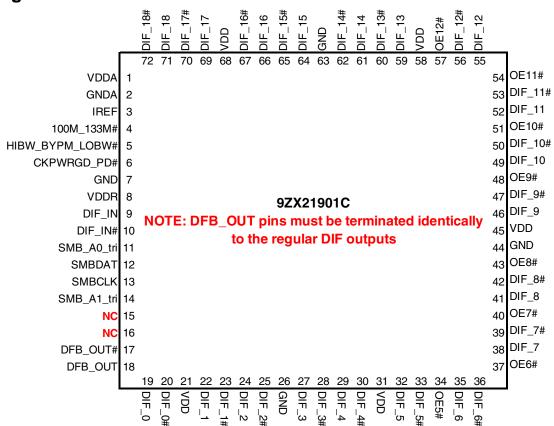
- Fixed feedback path/ 0ps input-to-output delay
- 9 Selectable SMBus addresses; Multiple devices can share same SMBus segment
- 8 dedicated OE# pins; hardware control of outputs
- PLL or bypass mode; PLL can dejitter incoming clock
- Selectable PLL BW; minimizes jitter peaking in downstream PLL's
- Spread spectrum compatible; tracks spreading input clock for EMI reduction
- SMBus Interface; unused outputs can be disabled
- 100MHz & 133.33MHz PLL mode; legacy QPI support
- Undriven differential outputs in Power Down mode for maximum power savings

Functional Block Diagram





Pin Configuration



72-pin VFQFPN

Functionality at Power Up (PLL Mode)

| r directionality at 1 ower | op (i EE Mode) | | | |
|----------------------------|-----------------|----------------|--|--|
| 100M_133M# | DIF_IN (MHz) | DIF_x (MHz) | | |
| 1 | 100.00 | DIF_IN | | |
| 0 | 133.33 | DIF_IN | | |

PLL Operating Mode Readback Table

| HiBW_BypM_LoBW# | Byte0, bit 7 | Byte 0, bit 6 | | | | | |
|-----------------|--------------|---------------|--|--|--|--|--|
| Low (Low BW) | 0 | 0 | | | | | |
| Mid (Bypass) | 0 | 1 | | | | | |
| High (High BW) | 1 | 1 | | | | | |

PLL Operating Mode

| HiBW_BypM_LoBW# | MODE |
|-----------------|-----------|
| Low | PLL Lo BW |
| Mid | Bypass |
| High | PLL Hi BW |

NOTE: PLL is OFF in Bypass Mode

Tri-level Input Thresholds

| Tri-level input Thresholds | | | | | |
|----------------------------|-----------------------------------|--|--|--|--|
| Level | Voltage | | | | |
| Low | <0.8V | | | | |
| Mid | 1.2 <vin<1.8v< td=""></vin<1.8v<> | | | | |
| High | Vin > 2.2V | | | | |

Power Connections

| Pin Nu | | |
|-----------------------|------------|--------------|
| VDD | GND | Description |
| 1 | 2 | Analog PLL |
| 8 | 7 | Analog Input |
| 21, 31, 45, 58, 68 | 26, 44, 63 | DIF clocks |

9ZX21901 SMBus Addressing

| Pi | n | SMBus Address |
|------------|------------|------------------|
| SMB_A1_tri | SMB_A0_tri | (Rd/Wrt bit = 0) |
| 0 | 0 | D8 |
| 0 | М | DA |
| 0 | 1 | DE |
| М | 0 | C2 |
| M | М | C4 |
| М | 1 | C6 |
| 1 | 0 | CA |
| 1 | M | CC |
| 1 | 1 | CE |



Pin Descriptions

| PIN# | PIN NAME | PIN TYPE | DESCRIPTION |
|------|-----------------|----------|---|
| 1 | VDDA | PWR | 3.3V power for the PLL core. |
| 2 | GNDA | GND | Ground pin for the PLL core. |
| 3 | IREF | OUT | This pin establishes the reference for the differential current-mode output pairs. It requires a fixed precision resistor to ground. 4750hm is the standard value for 1000hm differential impedance. Other impedances require different values. See data sheet. |
| 4 | 100M_133M# | IN | Input to select operating frequency 1 = 100MHz, 0 = 133.33MHz |
| 5 | HIBW_BYPM_LOBW# | IN | Trilevel input to select High BW, Bypass or Low BW mode. See PLL Operating Mode Table for Details. |
| 6 | CKPWRGD_PD# | IN | 3.3V Input notifies device to sample latched inputs and start up on first high assertion, or exit Power Down Mode on subsequent assertions. Low enters Power Down Mode. |
| 7 | GND | GND | Ground pin. |
| 8 | VDDR | PWR | 3.3V power for differential input clock (receiver). This VDD should be treated as an analog power rail and filtered appropriately. |
| 9 | DIF_IN | IN | 0.7 V Differential True input |
| 10 | DIF_IN# | IN | 0.7 V Differential Complementary Input |
| 11 | SMB_A0_tri | IN | SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A1 to decode 1 of 9 SMBus Addresses. |
| 12 | SMBDAT | I/O | Data pin of SMBUS circuitry, 5V tolerant |
| 13 | SMBCLK | IN | Clock pin of SMBUS circuitry, 5V tolerant |
| 14 | SMB_A1_tri | IN | SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A0 to decode 1 of 9 SMBus Addresses. |
| 15 | NC | N/A | No Connection. |
| 16 | NC | N/A | No Connection. |
| 17 | DFB_OUT# | OUT | Complementary half of differential feedback output, provides feedback signal to the PLL for synchronization with input clock to eliminate phase error. |
| 18 | DFB_OUT | OUT | True half of differential feedback output, provides feedback signal to the PLL for synchronization with the input clock to eliminate phase error. |
| 19 | DIF_0 | OUT | 0.7V differential true clock output |
| 20 | DIF_0# | OUT | 0.7V differential Complementary clock output |
| 21 | VDD | PWR | Power supply, nominal 3.3V |
| 22 | DIF_1 | OUT | 0.7V differential true clock output |
| 23 | DIF_1# | OUT | 0.7V differential Complementary clock output |
| 24 | DIF_2 | OUT | 0.7V differential true clock output |
| 25 | DIF_2# | OUT | 0.7V differential Complementary clock output |
| 26 | GND | GND | Ground pin. |
| 27 | DIF_3 | OUT | 0.7V differential true clock output |
| 28 | DIF_3# | OUT | 0.7V differential Complementary clock output |
| 29 | DIF_4 | OUT | 0.7V differential true clock output |
| 30 | DIF_4# | OUT | 0.7V differential Complementary clock output |
| 31 | VDD | PWR | Power supply, nominal 3.3V |
| 32 | DIF_5 | OUT | 0.7V differential true clock output |
| 33 | DIF_5# | OUT | 0.7V differential Complementary clock output |
| 34 | OE5# | IN | Active low input for enabling DIF pair 5. 1 =disable outputs, 0 = enable outputs |
| 35 | DIF_6 | OUT | 0.7V differential true clock output |
| 36 | DIF_6# | OUT | 0.7V differential Complementary clock output |



Pin Descriptions (cont.)

| 37 38 39 40 41 42 | PIN NAME OE6# DIF_7 DIF_7# | IN | Active low input for enabling DIF pair 6. 1 =disable outputs, 0 = enable outputs |
|----------------------------------|-------------------------------|-----|---|
| 38 39 40 41 | DIF_7 | | • |
| 39 40 41 | | | I =disable outbus. U = enable outbus |
| 40 41 | | OUT | 0.7V differential true clock output |
| 40 41 | | OUT | 0.7V differential Complementary clock output |
| 41 | 057" | INI | Active low input for enabling DIF pair 7. |
| | OE7# | IN | 1 =disable outputs, 0 = enable outputs |
| 40 | DIF_8 | OUT | 0.7V differential true clock output |
| 42 | DIF_8# | OUT | 0.7V differential Complementary clock output |
| 43 | OE8# | IN | Active low input for enabling DIF pair 8. |
| 43 | OL0# | IIN | 1 =disable outputs, 0 = enable outputs |
| 44 | GND | GND | Ground pin. |
| 45 | VDD | PWR | Power supply, nominal 3.3V |
| 46 | DIF_9 | OUT | 0.7V differential true clock output |
| 47 | DIF_9# | OUT | 0.7V differential Complementary clock output |
| 48 | OE9# | IN | Active low input for enabling DIF pair 9. |
| 40 | | | 1 =disable outputs, 0 = enable outputs |
| 49 | DIF_10 | OUT | 0.7V differential true clock output |
| 50 | DIF_10# | OUT | 0.7V differential Complementary clock output |
| 51 | OE10# | IN | Active low input for enabling DIF pair 10. |
| | | | 1 =disable outputs, 0 = enable outputs |
| 52 | DIF_11 | OUT | 0.7V differential true clock output |
| 53 | DIF_11# | OUT | 0.7V differential Complementary clock output |
| 54 | OE11# | IN | Active low input for enabling DIF pair 11. |
| | | | 1 =disable outputs, 0 = enable outputs |
| 55 | DIF_12 | OUT | 0.7V differential true clock output |
| 56 | DIF_12# | OUT | 0.7V differential Complementary clock output |
| 57 | OE12# | IN | Active low input for enabling DIF pair 12. |
| 50 | VDD | DWD | 1 =disable outputs, 0 = enable outputs |
| 58 | VDD | PWR | Power supply, nominal 3.3V |
| 59 | DIF_13 | OUT | 0.7V differential true clock output |
| 60 | DIF_13# | OUT | 0.7V differential Complementary clock output |
| 61 62 | DIF_14 DIF_14# | OUT | 0.7V differential true clock output |
| 63 | GND | GND | 0.7V differential Complementary clock output |
| 64 | DIF_15 | OUT | Ground pin. 0.7V differential true clock output |
| 65 | DIF_15# | OUT | 0.7V differential true clock output 0.7V differential Complementary clock output |
| 66 | DIF_16 | OUT | 0.7V differential complementary clock output |
| 67 | DIF_16# | OUT | 0.7V differential Complementary clock output |
| 68 | VDD | PWR | Power supply, nominal 3.3V |
| 69 | DIF_17 | OUT | 0.7V differential true clock output |
| 70 | DIF_17# | OUT | 0.7V differential Complementary clock output |
| 71 | DIF_18 | OUT | 0.7V differential true clock output |
| 72 | DIF_18# | OUT | 0.7V differential Complementary clock output |



Electrical Characteristics – Absolute Maximum Ratings

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|---------------------------|-------------|----------------------------|---------|-----|-----------------------|----------|-------|
| 3.3V Core Supply Voltage | VDDA | | | | 4.6 | V | 1,2 |
| 3.3V Logic Supply Voltage | VDD | | | | 4.6 | V | 1,2 |
| Input Low Voltage | V_{IL} | | GND-0.5 | | | ٧ | 1 |
| Input High Voltage | V_{IH} | Except for SMBus interface | | | V _{DD} +0.5V | V | 1 |
| Input High Voltage | V_{IHSMB} | SMBus clock and data pins | | | 5.5V | ٧ | 1 |
| Storage Temperature | Ts | | -65 | | 150 | °C | 1 |
| Junction Temperature | Tj | | | | 125 | °C | 1 |
| Case Temperature | Tc | | | | 110 | °C | 1 |
| Input ESD protection | ESD prot | Human Body Model | 2000 | • | | V | 1 |

¹Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics – DIF_IN Clock Input Parameters

T_{AMB}=T_{COM} unless otherwise indicated, Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| | | 11 7 0 1 | | | | | |
|----------------------------------|--------------------|--|-----|-----|-----|-------|-------|
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
| Input Crossover Voltage - DIF_IN | V _{CROSS} | Cross Over Voltage | 150 | | 900 | mV | 1 |
| Input Swing - DIF_IN | V_{SWING} | Differential value | 300 | | | mV | 1 |
| Input Slew Rate - DIF_IN | dv/dt | Measured differentially | 0.4 | | 8 | V/ns | 1,2 |
| Input Leakage Current | I _{IN} | $V_{IN} = V_{DD}$, $V_{IN} = GND$ | -5 | | 5 | uA | |
| Input Duty Cycle | d _{tin} | Measurement from differential wavefrom | 45 | | 55 | % | 1 |
| Input Jitter - Cycle to Cycle | J_{DIFIn} | Differential Measurement | 0 | | 125 | ps | 1 |

¹ Guaranteed by design and characterization, not 100% tested in production.

Electrical Characteristics – Current Consumption

 $TA = T_{COM}$; Supply Voltage VDD/VDDA = 3.3 V +/-5%, See Test Loads for Loading Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|--------------------------|-----------------------|---|-----|-----|-----|-------|-------|
| Operating Supply Current | I _{DD3.3OP} | All outputs active @100MHz, C _L = Full load; | | 407 | 500 | mA | 1 |
| Powerdown Current | I _{DD3.3PDZ} | All differential pairs tri-stated | | 12 | 36 | mA | 1 |

¹Guaranteed by design and characterization, not 100% tested in production.

² Operation under these conditions is neither implied nor guaranteed.

²Slew rate measured through +/-75mV window centered around differential zero



Electrical Characteristics – Input/Supply/Common Parameters

 $TA = T_{COM}$; Supply Voltage VDD/VDDA = 3.3 V +/-5%, See Test Loads for Loading Conditions

| COM, 117 | | | | | | | |
|----------------------------------|-----------------------|--|------------|--------|-----------------------|----------|-------|
| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
| Ambient Operating Temperature | T _{COM} | Commmercial range | 0 | | 70 | °C | 1 |
| Input High Voltage | V _{IH} | Single-ended inputs, except SMBus, low threshold and tri-level inputs | 2 | | V _{DD} + 0.3 | ٧ | 1 |
| Input Low Voltage | V_{IL} | Single-ended inputs, except SMBus, low threshold and tri-level inputs | GND - 0.3 | | 0.8 | V | 1 |
| | I _{IN} | Single-ended inputs, $V_{IN} = GND$, $V_{IN} = VDD$ | - 5 | | 5 | uA | 1 |
| Input Current | I _{INP} | $\label{eq:VIN} Single-ended inputs \\ V_{IN} = 0 \ V; \ Inputs \ with internal \ pull-up \ resistors \\ V_{IN} = VDD; \ Inputs \ with \ internal \ pull-down \ resistors$ | -200 | | 200 | uA | 1 |
| | F_{ibyp} | V _{DD} = 3.3 V, Bypass mode | 33 | | 400 | MHz | 2 |
| Input Frequency | F_{ipll} | $V_{DD} = 3.3 \text{ V}, 100\text{MHz PLL mode}$ | 90 | 100.00 | 105 | MHz | 2 |
| | F_{ipll} | $V_{DD} = 3.3 \text{ V}, 133.33 \text{MHz PLL mode}$ | 120 | 133.33 | 140 | MHz | 2 |
| Pin Inductance | L_{pin} | | | | 7 | nΗ | 1 |
| | C _{IN} | Logic Inputs, except DIF_IN | 1.5 | | 5 | pF | 1 |
| Capacitance | C _{INDIF_IN} | DIF_IN differential clock inputs | 1.5 | | 2.7 | pF | 1,4 |
| · | C _{OUT} | Output pin capacitance | | | 6 | pF | 1 |
| Clk Stabilization | T _{STAB} | From V _{DD} Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock | | | 1.8 | ms | 1,2 |
| Input SS Modulation Frequency | f _{MODIN} | Allowable Frequency (Triangular Modulation) | 30 | | 33 | kHz | 1 |
| OE# Latency | t _{LATOE#} | DIF start after OE# assertion DIF stop after OE# deassertion | 4 | | 12 | clocks | 1,3 |
| Tdrive_PD# | t _{DRVPD} | DIF output enable after PD# de-assertion | | | 300 | us | 1,3 |
| Tfall | t _F | Fall time of control inputs | | | 5 | ns | 1,2 |
| Trise | t _R | Rise time of control inputs | | | 5 | ns | 1,2 |
| SMBus Input Low Voltage | V_{ILSMB} | | | | 0.8 | V | 1 |
| SMBus Input High Voltage | V_{IHSMB} | | 2.1 | | V_{DDSMB} | V | 1 |
| SMBus Output Low Voltage | V_{OLSMB} | @ I _{PULLUP} | | | 0.4 | V | 1 |
| SMBus Sink Current | I _{PULLUP} | @ V _{OL} | 4 | | | mA | 1 |
| Nominal Bus Voltage | V_{DDSMB} | 3V to 5V +/- 10% | 2.7 | | 5.5 | V | 1 |
| SCLK/SDATA Rise Time | t _{RSMB} | (Max VIL - 0.15) to (Min VIH + 0.15) | | | 1000 | ns | 1 |
| SCLK/SDATA Fall Time | t _{FSMB} | (Min VIH + 0.15) to (Max VIL - 0.15) | | | 300 | ns | 1 |
| SMBus Operating Frequency | f _{MAXSMB} | Maximum SMBus operating frequency | | | 100 | kHz | 1,5 |

¹Guaranteed by design and characterization, not 100% tested in production.

²Control input must be monotonic from 20% to 80% of input swing.

³Time from deassertion until outputs are >200 mV

⁴ DIF_IN input

⁵The differential input clock must be running for the SMBus to be active



Electrical Characteristics – DIF 0.7V Current Mode Differential Outputs

TA = T_{COM}: Supply Voltage VDD/VDDA = 3.3 V +/-5%, See Test Loads for Loading Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|-------------------------|------------|---|------|-----|------|-------|---------|
| Slew rate | dV/dt | Scope averaging on | 1 | 2.5 | 4 | V/ns | 1, 2, 3 |
| Slew rate matching | ∆dV/dt | Slew rate matching, Scope averaging on | | | 20 | % | 1, 2, 4 |
| Rise/Fall Time Matching | ΔTrf | Rise/fall matching, Scope averaging off | | | 125 | ps | 1, 7, 8 |
| Voltage High | VHigh | Statistical measurement on single-ended signal using oscilloscope math function. (Scope | 660 | 750 | 850 | mV | 1 |
| Voltage Low | VLow | averaging on) | -150 | | 150 |] "" | 1 |
| Max Voltage | Vmax | Measurement on single ended signal using | | | 1150 | mV | 1 |
| Min Voltage | Vmin | absolute value. (Scope averaging off) | -300 | | | IIIV | 1 |
| Vswing | Vswing | Scope averaging off | 300 | | | mV | 1, 2 |
| Crossing Voltage (abs) | Vcross_abs | Scope averaging off | 250 | | 550 | mV | 1, 5 |
| Crossing Voltage (var) | Δ-Vcross | Scope averaging off | | | 140 | mV | 1, 6 |

 $^{^{1}}$ Guaranteed by design and characterization, not 100% tested in production. IREF = VDD/(3xR_R). For R_R = 475Ω (1%), I_{REF} = 2.32mA. I_{OH} = 6 x I_{REF} and V_{OH} = 0.7V @ Z_O=50Ω (100Ω differential impedance).

² Measured from differential waveform

³ Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

⁴ Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

⁵ Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

⁶ The total variation of all Vcross measurements in any particular system. Note that this is a subset of V_cross_min/max (V_cross absolute) allowed. The intent is to limit Vcross induced modulation by setting V_cross_delta to be smaller than V_cross absolute.

⁷ Measured from single-ended waveform

⁸ Measured with scope averaging off, using statistics function. Variation is difference between min and max.



Electrical Characteristics – Skew and Differential Jitter Parameters

TA = T_{COM}: Supply Voltage VDD/VDDA = 3.3 V +/-5%, See Test Loads for Loading Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|------------------------|-----------------------|---|------|-----|-----|-------------|-----------|
| CLK_IN, DIF[x:0] | t _{SPO_PLL} | Input-to-Output Skew in PLL mode nominal value @ 25°C, 3.3V | -100 | 0 | 100 | ps | 1,2,4,5,8 |
| CLK_IN, DIF[x:0] | t _{PD_BYP} | Input-to-Output Skew in Bypass mode nominal value @ 25°C, 3.3V | 2.5 | 3.5 | 4.5 | ns | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DSPO_PLL} | Input-to-Output Skew Varation in PLL mode across voltage and temperature | -50 | 0 | 50 | ps | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DSPO_BYP} | Input-to-Output Skew Varation in Bypass mode across voltage and temperature | -250 | | 250 | ps | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DTE} | Random Differential Tracking error beween two 9ZX devices in Hi BW Mode | | 3 | 5 | ps (rms) | 1,2,3,5,8 |
| CLK_IN, DIF[x:0] | t _{DSSTE} | Random Differential Spread Spectrum Tracking error beween two 9ZX devices in Hi BW Mode | | 15 | 75 | ps | 1,2,3,5,8 |
| DIF{x:0] | t _{SKEW_ALL} | Output-to-Output Skew across all outputs (Common to Bypass and PLL mode) | | 37 | 65 | ps | 1,2,3,8 |
| PLL Jitter Peaking | j peak-hibw | LOBW#_BYPASS_HIBW = 1 | 0 | 1.3 | 2.5 | dB | 7,8 |
| PLL Jitter Peaking | jpeak-lobw | LOBW#_BYPASS_HIBW = 0 | 0 | 0.8 | 2 | dB | 7,8 |
| PLL Bandwidth | pll _{HIBW} | LOBW#_BYPASS_HIBW = 1 | 2 | 3 | 4 | MHz | 8,9 |
| PLL Bandwidth | pll _{LOBW} | LOBW#_BYPASS_HIBW = 0 | 0.7 | 1.1 | 1.4 | MHz | 8,9 |
| Duty Cycle | t _{DC} | Measured differentially, PLL Mode | 45 | 50 | 55 | % | 1 |
| Duty Cycle Distortion | t _{DCD} | Measured differentially, Bypass Mode @100MHz | -2 | 0 | 2 | % | 1,10 |
| Jitter, Cycle to cycle | t. | PLL mode | | 41 | 50 | ps | 1,11 |
| onter, Cycle to cycle | t _{jcyc-cyc} | Additive Jitter in Bypass Mode | | 20 | 50 | ps | 1,11 |

Notes for preceding table:

¹ Measured into fixed 2 pF load cap. Input to output skew is measured at the first output edge following the corresponding input.

² Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

³ All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

⁴ This parameter is deterministic for a given device

⁵ Measured with scope averaging on to find mean value. DIF_IN slew rate must be matched to DIF output slew rate.

⁶.t is the period of the input clock

⁷ Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.

^{8.} Guaranteed by design and characterization, not 100% tested in production.

⁹ Measured at 3 db down or half power point.

¹⁰ Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

¹¹ Measured from differential waveform



Electrical Characteristics – Phase Jitter Parameters

TA = T_{COM}; Supply Voltage VDD/VDDA = 3.3 V +/-5%, See Test Loads for Loading Conditions

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|------------------------------------|-------------------------|--|------|------|-----|-------------|---------|
| | t _{jphPCleG1} | PCIe Gen 1 | | 39 | 86 | ps (p-p) | 1,2,3 |
| | | PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz | | 1.1 | 3 | ps (rms) | 1,2 |
| Jitter, Phase | t _{jphPCleG2} | PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz) | | 2.6 | 3.1 | ps (rms) | 1,2 |
| | t _{jphPCleG3} | PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz) | | 0.6 | 1 | ps (rms) | 1,2,4 |
| | | QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI) | | 0.36 | 0.5 | ps (rms) | 1,5 |
| | t _{jphQPI_SMI} | QPI & SMI (100MHz, 8.0Gb/s, 12UI) | 0.23 | | 0.3 | ps (rms) | 1,5 |
| | | QPI & SMI (100MHz, 9.6Gb/s, 12UI) | | 0.18 | 0.2 | ps (rms) | 1,5 |
| | t _{iphPCleG1} | PCIe Gen 1 | | 4 | 10 | ps (p-p) | 1,2,3 |
| | | PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz | | 0.25 | 0.3 | ps (rms) | 1,2,6 |
| | t _{jphPCleG2} | PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz) | | 0.57 | 0.7 | ps (rms) | 1,2,6 |
| Additive Phase Jitter, Bypass mode | t _{jphPCleG3} | PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz) | | 0.20 | 0.3 | ps (rms) | 1,2,4,6 |
| Bypass mode | | QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI) | | 0.22 | 0.3 | ps (rms) | 1,5,6 |
| | t _{jphQPI_SMI} | QPI & SMI (100MHz, 8.0Gb/s, 12UI) | | 0.08 | 0.1 | ps (rms) | 1,5,6 |
| | | QPI & SMI (100MHz, 9.6Gb/s, 12UI) | | 0.08 | 0.1 | ps (rms) | 1,5,6 |

¹ Applies to all outputs.

Power Management Table

| Inputs | | Control Bits/Pins | | | | | |
|-------------|--------------------|-------------------|---|-------------------|--|-------------------|--------------|
| CKPWRGD_PD# | DIF_IN/ DIF_IN# | SMBus EN bit | | | IF(5:12)/ Other DIF/ DFB_OUT/ IF(5:12)# DIF# DFB_OUT# | | PLL State |
| 0 | Х | Х | Х | Hi-Z ¹ | Hi-Z ¹ | Hi-Z ¹ | OFF |
| | | 0 | Χ | Hi-Z ¹ | Hi-Z ¹ | Running | ON |
| 1 | Running | 1 | 0 | Running | Running | Running | ON |
| | | 1 | 1 | Hi-Z ¹ | Running | Running | ON |

NOTE: 1. Due to external pull down resistors, HI-Z results in Low/Low on the True/Complement outputs

² See http://www.pcisig.com for complete specs

³ Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

⁴ Subject to final radification by PCI SIG.

⁵ Calculated from Intel-supplied Clock Jitter Tool v 1.6.3

⁶ For RMS figures, additive jitter is calculated by solving the following equation: (Additive jitter)² = (total jitter)² - (input jitter)²



Clock Periods - Differential Outputs with Spread Spectrum Disabled

| | | | Measurement Window | | | | | | | |
|---------|------------------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
| | 0 | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | | |
| SSC OFF | Center Freq. MHz | -c2c jitter AbsPer Min | -SSC Short-Term Average Min | - ppm Long-Term Average Min | 0 ppm Period Nominal | + ppm Long-Term Average Max | +SSC Short-Term Average Max | +c2c jitter AbsPer Max | Units | Notes |
| DIF | 100.00 | 9.94900 | | 9.99900 | 10.00000 | 10.00100 | | 10.05100 | ns | 1,2,3 |
| DIF | 133.33 | 7.44925 | | 7.49925 | 7.50000 | 7.50075 | | 7.55075 | ns | 1,2,4 |

Clock Periods - Differential Outputs with Spread Spectrum Enabled

| | | | Measurement Window | | | | | | | |
|--------|------------------------|------------------------------|--------------------------------------|--------------------------------------|----------------------------|--------------------------------------|--------------------------------------|------------------------------|-------|-------|
| SSC ON | Center Freq. MHz | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | | |
| | | -c2c jitter AbsPer Min | -SSC Short-Term Average Min | - ppm Long-Term Average Min | 0 ppm Period Nominal | + ppm Long-Term Average Max | +SSC Short-Term Average Max | +c2c jitter AbsPer Max | Units | Notes |
| DIF | 99.75 | 9.94906 | 9.99906 | 10.02406 | 10.02506 | 10.02607 | 10.05107 | 10.10107 | ns | 1,2,3 |
| DIF | 133.00 | 7.44930 | 7.49930 | 7.51805 | 7.51880 | 7.51955 | 7.53830 | 7.58830 | ns | 1,2,4 |

Notes:

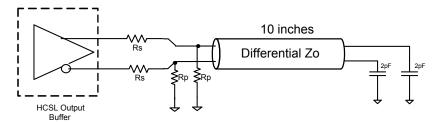
Thermal Characteristics

| Parameter | Symbol | Conditions | Min. | Тур. | Max. | Units |
|--|--------|----------------|------|------|------|-------|
| Thermal Resistance Junction to Ambient | θЈА | Still air | | 26.2 | | °C/W |
| | θЈА | 1 m/s air flow | | 23.1 | | °C/W |
| | θЈА | 3 m/s air flow | | 19.6 | | °C/W |
| Thermal Resistance Junction to Case | θЈС | | | 10.4 | | °C/W |
| Thermal Resistance Junction to Board | θЈВ | | | 0.3 | | °C/W |

Differential Output Termination Table

| DIF Zo (Ω) | Iref (Ω) | Rs (Ω) | Rp (Ω) |
|------------|----------|---------------|--------------|
| 100 | 475 | 33 | 50 |
| 85 | 412 | 27 | 42.2 or 43.2 |

9ZX21901 Differential Test Loads



¹Guaranteed by design and characterization, not 100% tested in production.

² All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (+/-100ppm). The 96Z61027 itself does not contribute to ppm error.

³ Driven by SRC output of main clock, 100 MHz PLL Mode or Bypass mode

⁴ Driven by CPU output of main clock, 133 MHz PLL Mode or Bypass mode



General SMBus Serial Interface Information (see also 9ZX21901 SMBus Addressing on page 2)

How to Write

- Controller (host) sends a start bit
- Controller (host) sends the write address XX_(H)
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) sends the byte count = X
- IDT clock will acknowledge
- Controller (host) starts sending Byte N through Byte N+X-1
- IDT clock will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

| | Index BI | ock W | /rite Operation |
|-----------|---------------------|------------|----------------------|
| Controll | er (Host) | | IDT (Slave/Receiver) |
| T | starT bit | | |
| Slave A | Address | | |
| WR | WRite | | |
| | | | ACK |
| Beginning | g Byte = N | | |
| | | | ACK |
| Data Byte | Data Byte Count = X | | |
| | | | ACK |
| Beginnir | ng Byte N | | |
| | | | ACK |
| 0 | | $ \times $ | |
| 0 | | X Byte | 0 |
| 0 | | O | 0 |
| | | | 0 |
| Byte N | + X - 1 | | |
| | | | ACK |
| Р | stoP bit | | |

Note: $XX_{(H)}$ is defined by SMBus Address select pins.

How to Read

- Controller (host) will send a start bit
- Controller (host) sends the write address XX_(H)
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address YY_(H)
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N+X-1
- IDT clock sends Byte 0 through Byte X (if X_(H) was written to Byte 8)
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

| | Index Block F | Read O | peration |
|------|-----------------|--------|----------------------|
| Cor | ntroller (Host) | | IDT (Slave/Receiver) |
| Т | starT bit | | |
| SI | ave Address | | |
| WR | WRite | | |
| | | | ACK |
| Begi | nning Byte = N | | |
| | | | ACK |
| RT | Repeat starT | | |
| SI | ave Address | | |
| RD | ReaD | | |
| | | | ACK |
| | | | |
| | | | Data Byte Count=X |
| | ACK | | |
| | | | Beginning Byte N |
| | ACK | | |
| | | ē | 0 |
| | 0 | X Byte | 0 |
| | 0 | | 0 |
| | 0 | | |
| | | | Byte N + X - 1 |
| N | Not acknowledge | | |
| Р | stoP bit | | |



SMBusTable: PLL Mode, and Frequency Select Register

| Byte | 0 Pin# | Name | Control Function | Type | 0 | 1 | Default |
|-------|--------|------------|----------------------------------|------------------|------------------------|--------|---------|
| Bit 7 | 5 | PLL Mode 1 | PLL Operating Mode Rd back 1 | R | See PLL Operating Mode | | Latch |
| Bit 6 | 5 | PLL Mode 0 | PLL Operating Mode Rd back 0 | R Readback Table | | Latch | |
| Bit 5 | 72/71 | DIF_18_En | Output Control overrides OE# pin | RW | Hi-Z | Enable | 1 |
| Bit 4 | 70/69 | DIF_17_En | Output Control overrides OE# pin | RW | Hi-Z | Enable | 1 |
| Bit 3 | 67/66 | DIF_16_En | Output Control overrides OE# pin | RW | Hi-Z | Enable | 1 |
| Bit 2 | | | Reserved | | | | 0 |
| Bit 1 | | Reserved | | | | | |
| Bit 0 | 4 | 100M 133M# | Frequency Select Readback | R | 133MHz | 100MHz | Latch |

SMBusTable: Output Control Register

| Byte | 1 Pin # | Name | Control Function | Type | 0 | 1 | Default |
|-------|---------|----------|----------------------------------|------|------|--------|---------|
| Bit 7 | 39/38 | DIF_7_En | Output Control overrides OE# pin | RW | | | 1 |
| Bit 6 | 35/36 | DIF_6_En | Output Control overrides OE# pin | RW | | | 1 |
| Bit 5 | 32/33 | DIF_5_En | Output Control overrides OE# pin | RW | | | 1 |
| Bit 4 | 29/30 | DIF_4_En | Output Control overrides OE# pin | RW | Hi-Z | Enable | 1 |
| Bit 3 | 27/28 | DIF_3_En | Output Control overrides OE# pin | RW | □ -∠ | | 1 |
| Bit 2 | 24/25 | DIF_2_En | Output Control overrides OE# pin | RW | | | 1 |
| Bit 1 | 22/23 | DIF_1_En | Output Control overrides OE# pin | RW | Ī | | |
| Bit 0 | 19/20 | DIF 0 Fn | Output Control overrides OF# pin | RW | 1 | | 1 |

SMBusTable: Output Control Register

| Byte | Byte 2 Pin # Name | | Control Function | Type | 0 | 1 | Default |
|-------|--|--|----------------------------------|--------|-------|---------|---------|
| Bit 7 | 65/64 DIF_15_En Output Control overrides OE# pin | | Output Control overrides OE# pin | RW | | | 1 |
| Bit 6 | 62/61 | DIF_14_En | Output Control overrides OE# pin | RW | | | 1 |
| Bit 5 | 60/59 | DIF_13_En | Output Control overrides OE# pin | RW | | | 1 |
| Bit 4 | 56/55 | 56/55 DIF_12_En Output Control overrides OE# pin RW Hi-Z Ena | | Enable | 1 | | |
| Bit 3 | 53/52 | DIF_11_En | Output Control overrides OE# pin | RW | 111-2 | Lilable | 1 |
| Bit 2 | 50/49 | DIF_10_En | Output Control overrides OE# pin | RW | | | 1 |
| Bit 1 | 47/46 | 47/46 DIF_9_En Output Control overrides OE# pin RW | | | 1 | | |
| Bit 0 | 42/41 | DIF_8_En | Output Control overrides OE# pin | RW | | | 1 |

SMBusTable: Output Enable Pin Status Readback Register

| Byte | 93 Pin# | Name | Control Function | Function Type | | 1 | Default |
|-------|---------|---------|-----------------------------|---------------|--------------|--------------|-----------|
| Bit 7 | 57 | OE_RB12 | Real Time readback of OE#12 | R | | | Real time |
| Bit 6 | 54 | OE_RB11 | Real Time readback of OE#11 | R | | | Real time |
| Bit 5 | 51 | OE_RB10 | Real Time readback of OE#10 | R | | | Real time |
| Bit 4 | 48 | OE_RB9 | Real Time readback of OE#9 | R | OE# pin Low | OE# Pin High | Real time |
| Bit 3 | 43 | OE_RB8 | Real Time readback of OE#8 | R | OE# pill Low | | Real time |
| Bit 2 | 40 | OE_RB7 | Real Time readback of OE#7 | R | | | Real time |
| Bit 1 | 37 | OE_RB6 | Real Time readback of OE#6 | R | | | Real time |
| Bit 0 | 34 | OE_RB5 | Real Time readback of OE#5 | R | | | Real time |

SMBusTable: Reserved Register

| Byte | e 4 | Pin # | Name | Control Function | Type | 0 | 1 | Default | | |
|-------|-----|----------|----------|------------------|------|---|---|---------|--|--|
| Bit 7 | | Reserved | | | | | | | | |
| Bit 6 | | | | Reserved | | | | 0 | | |
| Bit 5 | | | | Reserved | | | | | | |
| Bit 4 | | | | Reserved | | | | 0 | | |
| Bit 3 | | | | Reserved | | | | | | |
| Bit 2 | | | Reserved | | | | | | | |
| Bit 1 | | | Reserved | | | | | | | |
| Bit 0 | | | Reserved | | | | | | | |



SMBusTable: Vendor & Revision ID Register

| Byte 5 Pin # | | Name | Control Function | Type | 0 | 1 | Default |
|--------------|---|------|------------------|------|-------|--------|---------|
| Bit 7 | - | RID3 | | R | | | Х |
| Bit 6 | - | RID2 | REVISION ID | R | B rev | = 0001 | X |
| Bit 5 | - | RID1 | REVISION ID | R | C Rev | = 0010 | Х |
| Bit 4 | - | RID0 | | R | | | Х |
| Bit 3 | - | VID3 | | R | - | - | 0 |
| Bit 2 | - | VID2 | VENDOR ID | R | - | - | 0 |
| Bit 1 | - | VID1 | VENDOR ID | R | - | - | 0 |
| Bit 0 | - | VID0 | | R | - | - | 1 |

SMBusTable: DEVICE ID

| Byte 6 Pin # | | Pin # Name Control Function | | Туре | 0 | 1 | Default |
|--------------|---|-----------------------------|------------------|------|-----------------------------|------|---------|
| Bit 7 | - | De | evice ID 7 (MSB) | R | | | 1 |
| Bit 6 | - | | Device ID 6 | R | 7 | | 1 |
| Bit 5 | - | | Device ID 5 | | 1 | | 0 |
| Bit 4 | - | | Device ID 4 | | Device ID is 219 decimal or | | 1 |
| Bit 3 | - | | Device ID 3 | R | DB | hex. | 1 |
| Bit 2 | - | | Device ID 2 | | | | 0 |
| Bit 1 | - | Device ID 1 | | R | | | 1 |
| Bit 0 | - | | Device ID 0 | R | | | 1 |

SMBusTable: Byte Count Register

| Byte 7 Pin # | | Name | Control Function | Type | 0 | 1 | Default | |
|--------------|---|----------|---|-----------|------------------|------------------|---------|--|
| Bit 7 | | | Reserved | . , , , , | | · | 0 | |
| Bit 6 | | | Reserved | | | | | |
| Bit 5 | | Reserved | | | | | | |
| Bit 4 | - | BC4 | | RW | | | 0 | |
| Bit 3 | - | BC3 | Writing to this register configures how | RW | Default value | is 8 hex, so 9 | 1 | |
| Bit 2 | - | BC2 | many bytes will be read back. | RW | bytes (0 to 8) w | ill be read back | 0 | |
| Bit 1 | - | BC1 | many bytes will be read back. | RW | by de | efault. | 0 | |
| Bit 0 | - | BC0 | | RW | | | 0 | |

SMBusTable: Reserved Register

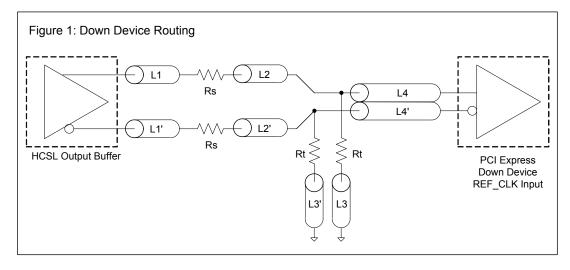
| OMBUSTUBIC: Tieserveu Tiegistei | | | | | | | | | |
|---------------------------------|--|----------|------------------|------|---|---|---------|--|--|
| Byte 8 Pin # | | Name | Control Function | Type | 0 | 1 | Default | | |
| Bit 7 | | | Reserved | | | | | | |
| Bit 6 | | | Reserved | | | | 0 | | |
| Bit 5 | | | Reserved | | | | | | |
| Bit 4 | | | Reserved | | | | 0 | | |
| Bit 3 | | | Reserved | | | | 0 | | |
| Bit 2 | | Reserved | | | | | | | |
| Bit 1 | | Reserved | | | | | | | |
| Bit 0 | | Reserved | | | | | | | |

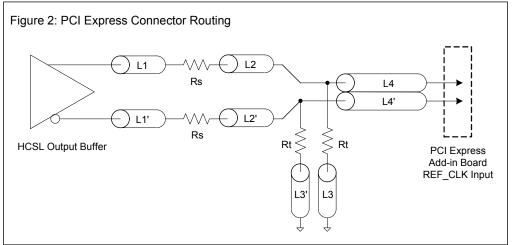


| DIF Reference Clock | | | | | | |
|---|--------------------|------|--------|--|--|--|
| Common Recommendations for Differential Routing | Dimension or Value | Unit | Figure | | | |
| L1 length, route as non-coupled 50ohm trace | 0.5 max | inch | 1 | | | |
| L2 length, route as non-coupled 50ohm trace | 0.2 max | inch | 1 | | | |
| L3 length, route as non-coupled 50ohm trace | 0.2 max | inch | 1 | | | |
| Rs | 33 | ohm | 1 | | | |
| Rt | 49.9 | ohm | 1 | | | |

| Down Device Differential Routing | | |
|--|---------------|--|
| L4 length, route as coupled microstrip 100ohm differential trace 2 min to 16 | nax inch 1 | |
| L4 length, route as coupled stripline 100ohm differential trace 1.8 min to 1 | .4 max inch 1 | |

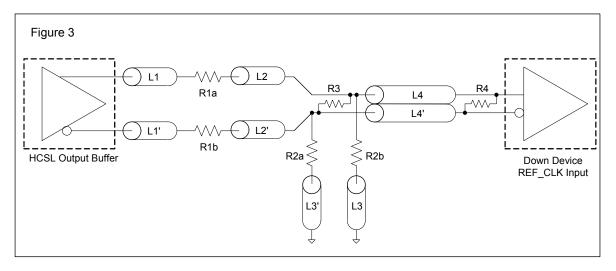
| Differential Routing to PCI Express Connector | | | |
|--|-----------------------|------|---|
| L4 length, route as coupled microstrip 100ohm differential trace | 0.25 to 14 max | inch | 2 |
| L4 length, route as coupled stripline 100ohm differential trace | 0.225 min to 12.6 max | inch | 2 |



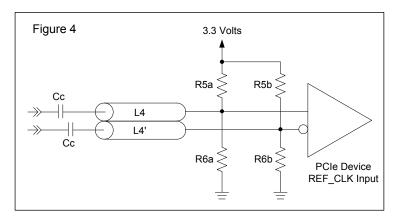


| | Alternative Termination for LVDS and other Common Differential Signals (figure 3) | | | | | | |
|-------|---|------|----|------|------|-----|--------------------------------|
| Vdiff | Vp-p | Vcm | R1 | R2 | R3 | R4 | Note |
| 0.45v | 0.22v | 1.08 | 33 | 150 | 100 | 100 | |
| 0.58 | 0.28 | 0.6 | 33 | 78.7 | 137 | 100 | |
| 0.80 | 0.40 | 0.6 | 33 | 78.7 | none | 100 | ICS874003i-02 input compatible |
| 0.60 | 0.3 | 1.2 | 33 | 174 | 140 | 100 | Standard LVDS |

R1a = R1b = R1R2a = R2b = R2

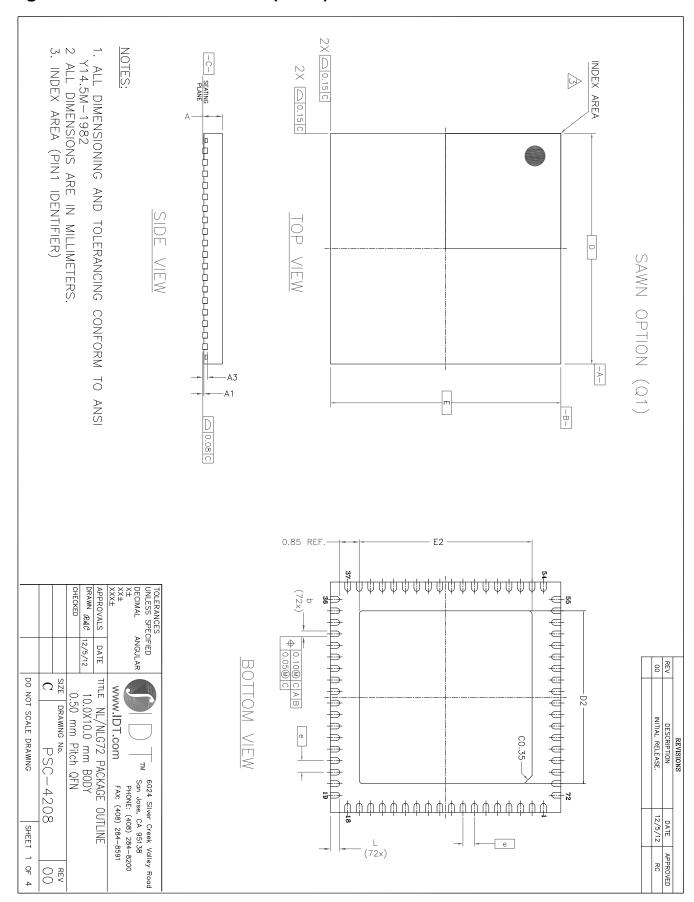


| Cable Connected AC Coupled Application (figure 4) | | | | | |
|---|-------------|------|--|--|--|
| Component | Value | Note | | | |
| R5a, R5b | 8.2K 5% | | | | |
| R6a, R6b | 1K 5% | | | | |
| Cc | 0.1 μF | | | | |
| Vcm | 0.350 volts | | | | |



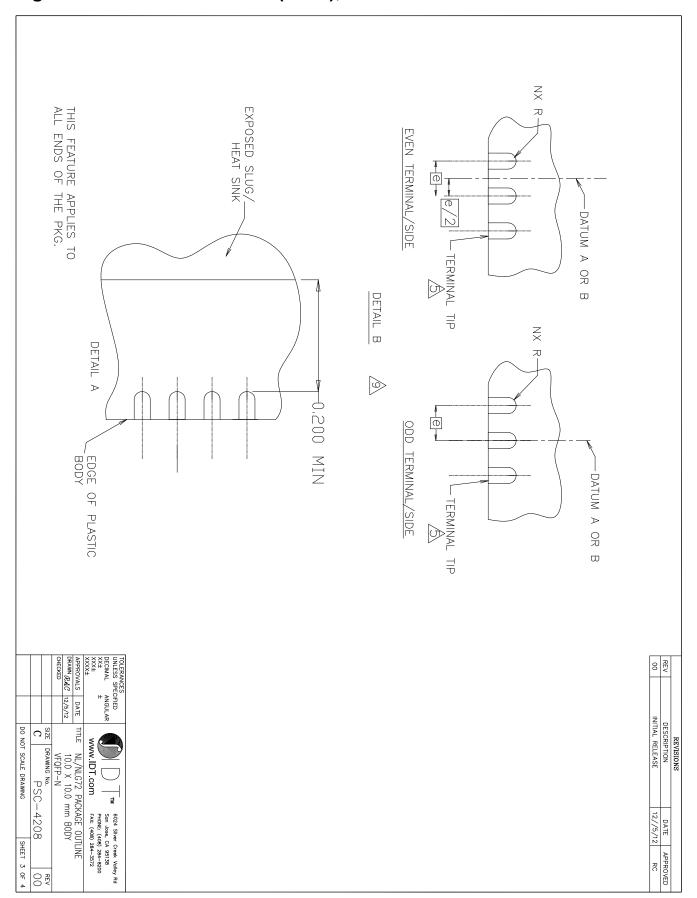


Package Outline and Dimensions (NL72)





Package Outline and Dimensions (NL72), cont.





Package Outline and Dimensions (NL72) cont. – use EPAD Option P3 and Lead Option Z2

| THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JEDEC PUB. 95 SEC. 4.3 SPP-002. DETAILS OF TERMINA IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE. DIMENSION 6 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25mm AND 0.30mm FROM TERMINAL TIP. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY. T. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION. | SYMBOL 0.40mm 0.50mm SYMBOL 0.10 0.15 dad 0.10 0.10 ccc 0.10 0.10 ddd 0.05 0.05 NOTES: 1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994. 2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES. 3. N IS THE TOTAL NUMBER OF TERMINALS. Nd IS THE NUMBER OF TERMINALS IN X-DIRECTION & Ne IS THE NUMBER OF TERMINALS IN Y-DIRECTION. | SAW VERSION: S DIMENSION MIN. NOM. MAX. D2 SEE EPAD OPTION E2 SEE EPAD OPTION K 0.20 6 Nd 18 6 Ne 18 6 TOLERANCE OF FORM & POSITION TOLERANCE OF FORM & POSITION |
|--|--|---|
| NUMBERING CONVENTION 3 SPP-002. DETAILS OF TERMINAL #1 CATED WITHIN THE ZONE Y BE EITHER A MOLD INAL AND IS MEASURED BETWEEN RMINALS ON EACH D AND E CAL FASHION. | ASME Y14.5M-1994. ES ARE IN DEGREES. RECTION & RECTION. | EPAD OPTION: P1 MIN. NOM. E2 7.40 7.50 D2 7.40 7.50 LEAD OPTION MIN. NOM. O.45 0.50 |
| AND DO COMPANY OF THE PROPERTY | COMMON SYMBOL A A O.S A1 O.S A1 O.S A1 O.S B1 R1 R1 R ref R ref. b min NOTES b O.S | MAX. MIN. 5.90 5.90 MAX. MIN. 0.55 0.30 |
| DIMENSION NOM. MAX. REPAD OPTION 9.75 BSC 9.75 BSC 18 18 6 0.65 1.00 | ON DIMENSIONS MIN NOM MAX 0.80 0.90 1.00 0.02 0.05 - 0.20 ref - 14 - 0.20 - 14 - 0.20 - 14 - 0.20 - 0.30 min/2 1,2 0.18 0.25 0.30 0.50 BSC 10.00 BSC | P2 NOM. MAX. 6.00 6.10 6.00 6.10 NOM. MAX. 0.40 050 |
| TOLERANCES UNLESS SPECIFED DECINAL ANGULAR XXX± XXX± XXXX± XXXXX APPROVALS DATE TITLE N DRAWN (BACC 12/5/72 V CHECKED C DR. SZE DR. 1 DO NOT SI | | REVISIONS REVISIONS REV DESCRIPTION OO INITIAL RELEASE P 3 MIN. NOM. 5.80 5.90 5.80 5.90 5.90 |
| WWW.IDT.com The NL/NIG72 PACKAGE OUTLINE 10.0 X 10.0 mm BODY VFQFP-N SZE PRAWNG No. PSC-4208 DO NOT SCALE DRAWNG SHORT Creek Valley Rd Son John, CA 95138 PHONE (106) 284-2572 PACKAGE OUTLINE 10.0 X 10.0 mm BODY VFQFP-N SZE PSC-4208 SHEET 4 0F 4 | | NONS DATE APPROVED |



Marking Diagram



Notes:

- 1. "LOT" is the lot sequence number.
- 2. "COO" denotes country of origin.
- 3. "YYWW" is the last two digits of the year and week that the part was assembled.
- 4. "LF" denotes RoHS compliant package.

Ordering Information

| Part / Order Number | t / Order Number Shipping Package F | | Temperature |
|---------------------|---|---------------|-------------|
| 9ZX21901CKLF | Trays | 72-pin VFQFPN | 0 to +70°C |
| 9ZX21901CKLFT | Tape and Reel | 72-pin VFQFPN | 0 to +70°C |

Revision History

| Rev. | Issue Date | Who | Description | Page # |
|-------------|-------------|--|--|---------|
| K 4 | 4/15/2013 | IKIJVVI | 1. Corrected typo in OE# Latency parameter; changed 1 min. to 3 max. cycles to 4 | 5 |
| N. | K 4/15/2013 | | min. to 12 max. clocks. | |
| L | 1/30/2015 | DC | Updated package dimensions and outline drawing with NL72 SAWN version. | Various |
| M 4/23/2015 | 4/00/0015 | | Added marking diagram and associated notes. | Various |
| | | 2. Re-created datasheet in latesrt IDT template. | various | |
| N | 11/19/2015 | 1/19/2015 RDW | Update Input Clock spec with new standardized table matching PCIe SIG input | 5 |
| | | | specs. | |



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